

STM32WL_QFN48_4Layers_WMBUS169MHz_RefBoard

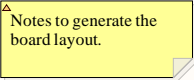
MB1792

Table of contents

Sheet 1: Project overview (this page)
Reference_Design_STM32WL_4L_wM-Bus.SchDoc

Legend

- General comment such as function title, configuration, ...
- Text to be added to silkscreen.
- Warning text.



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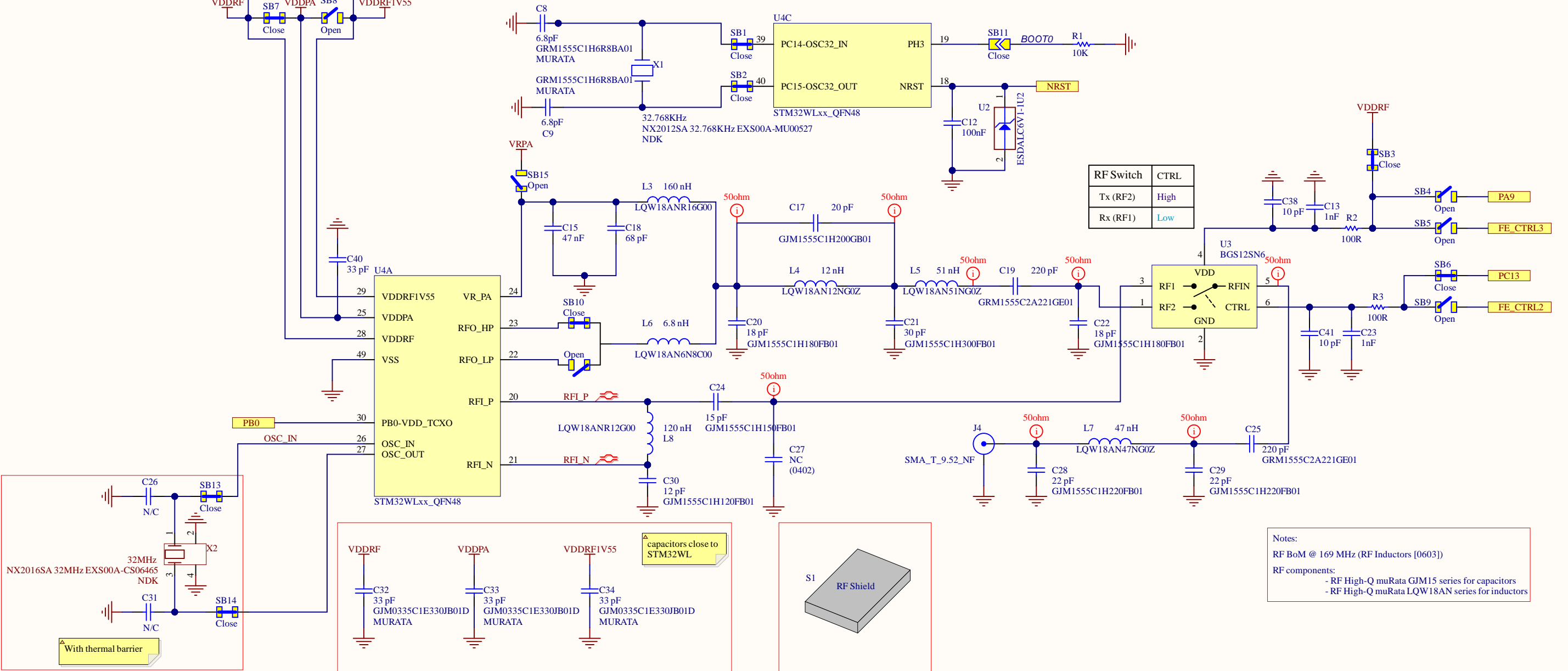
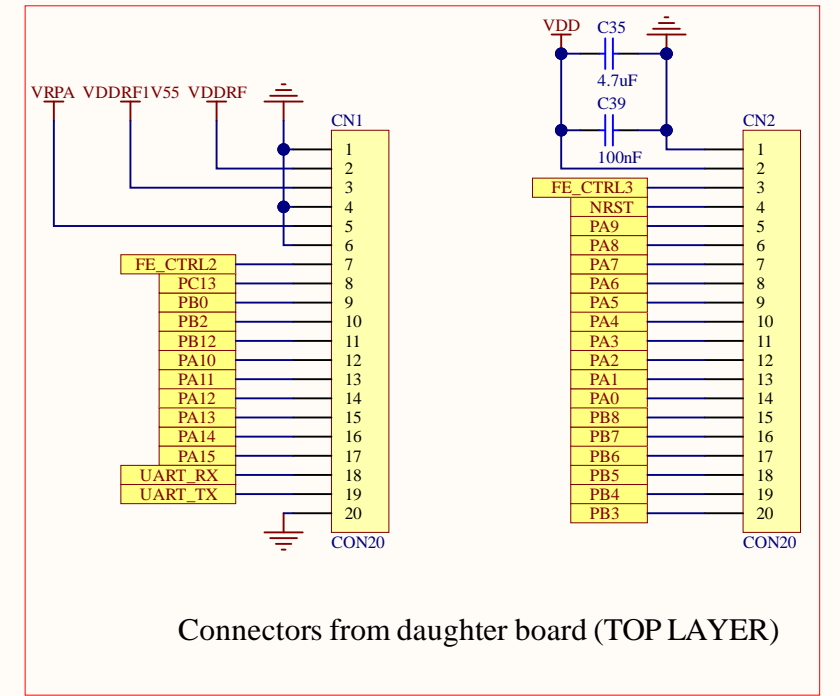
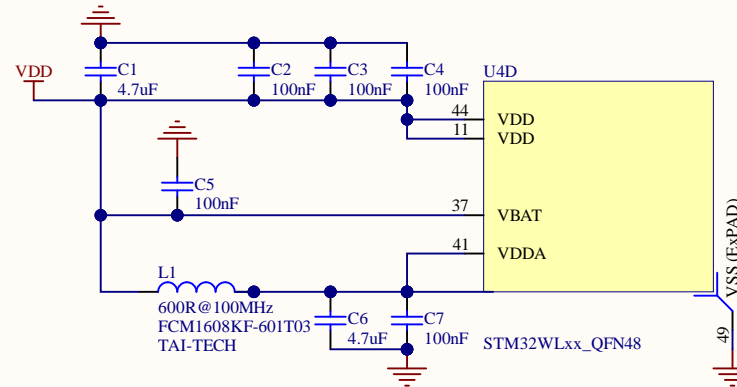
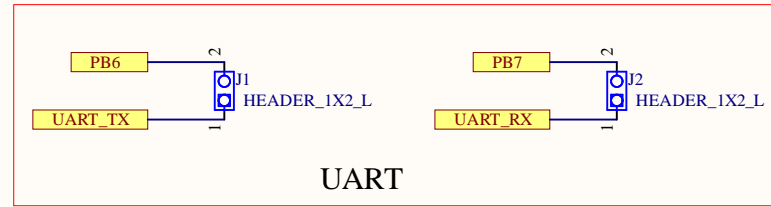
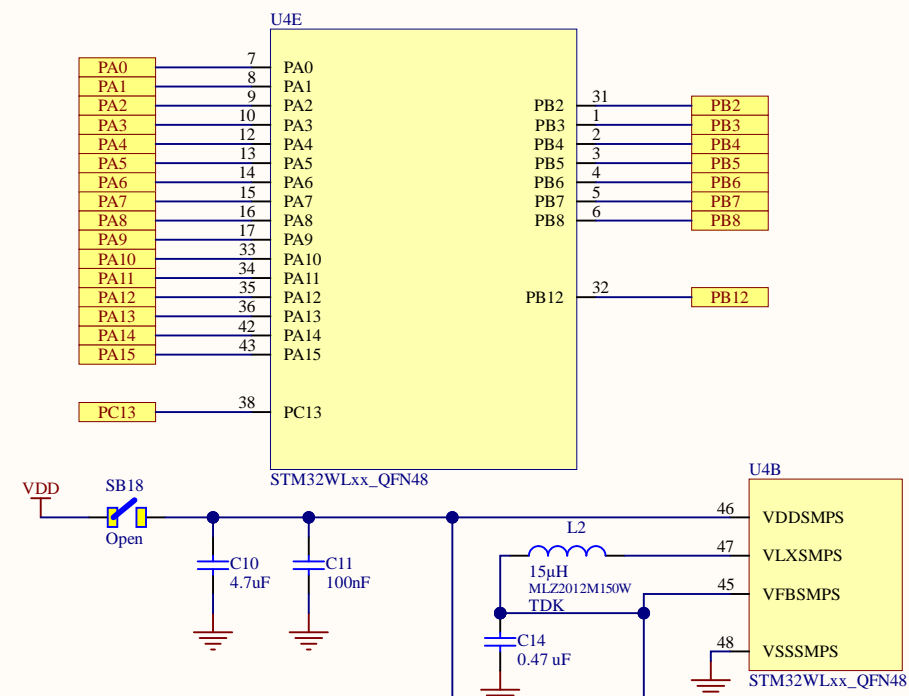
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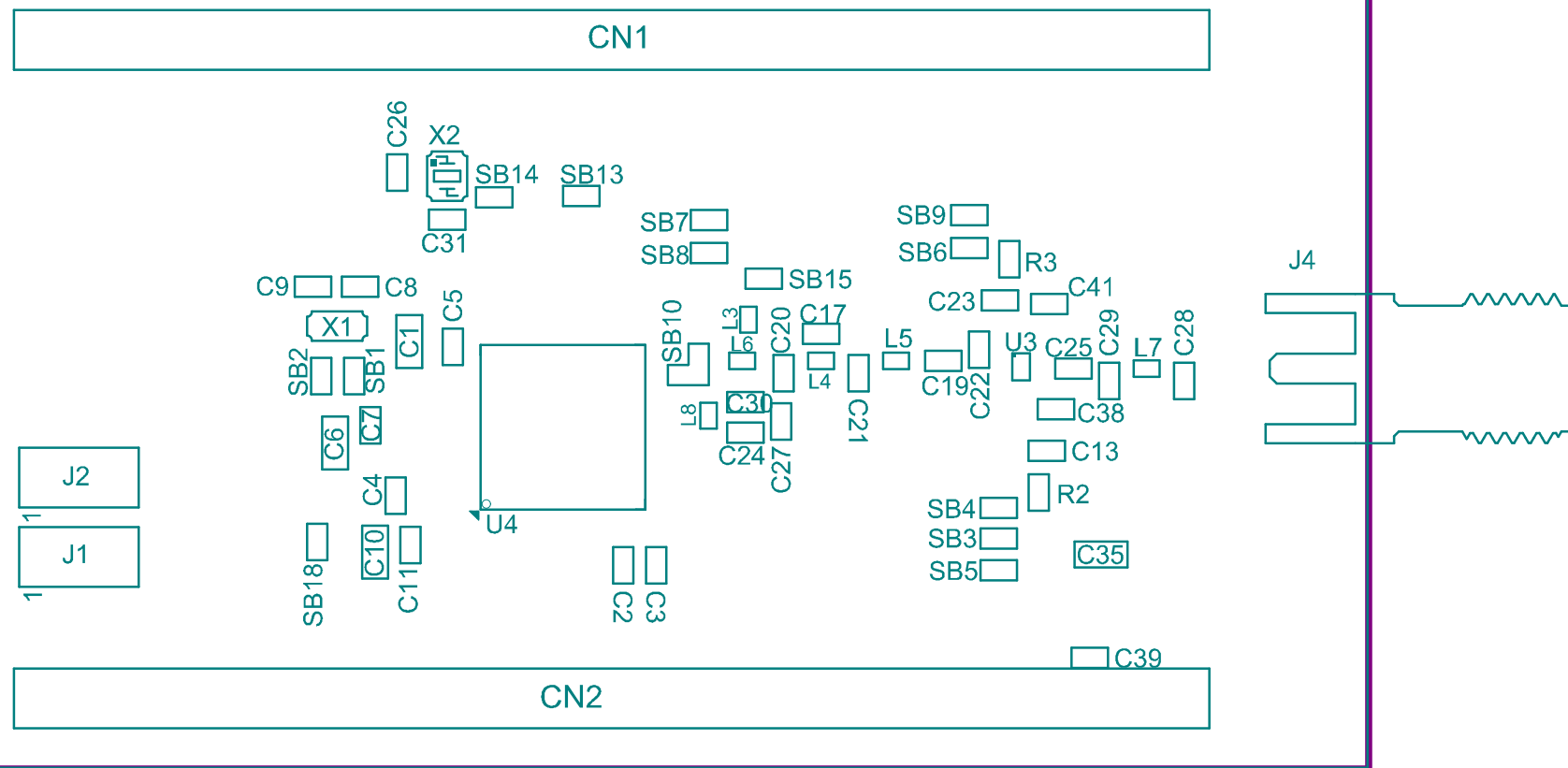
U_Top
Reference_Design_STM32WL_4L_wM-Bus.SchDoc




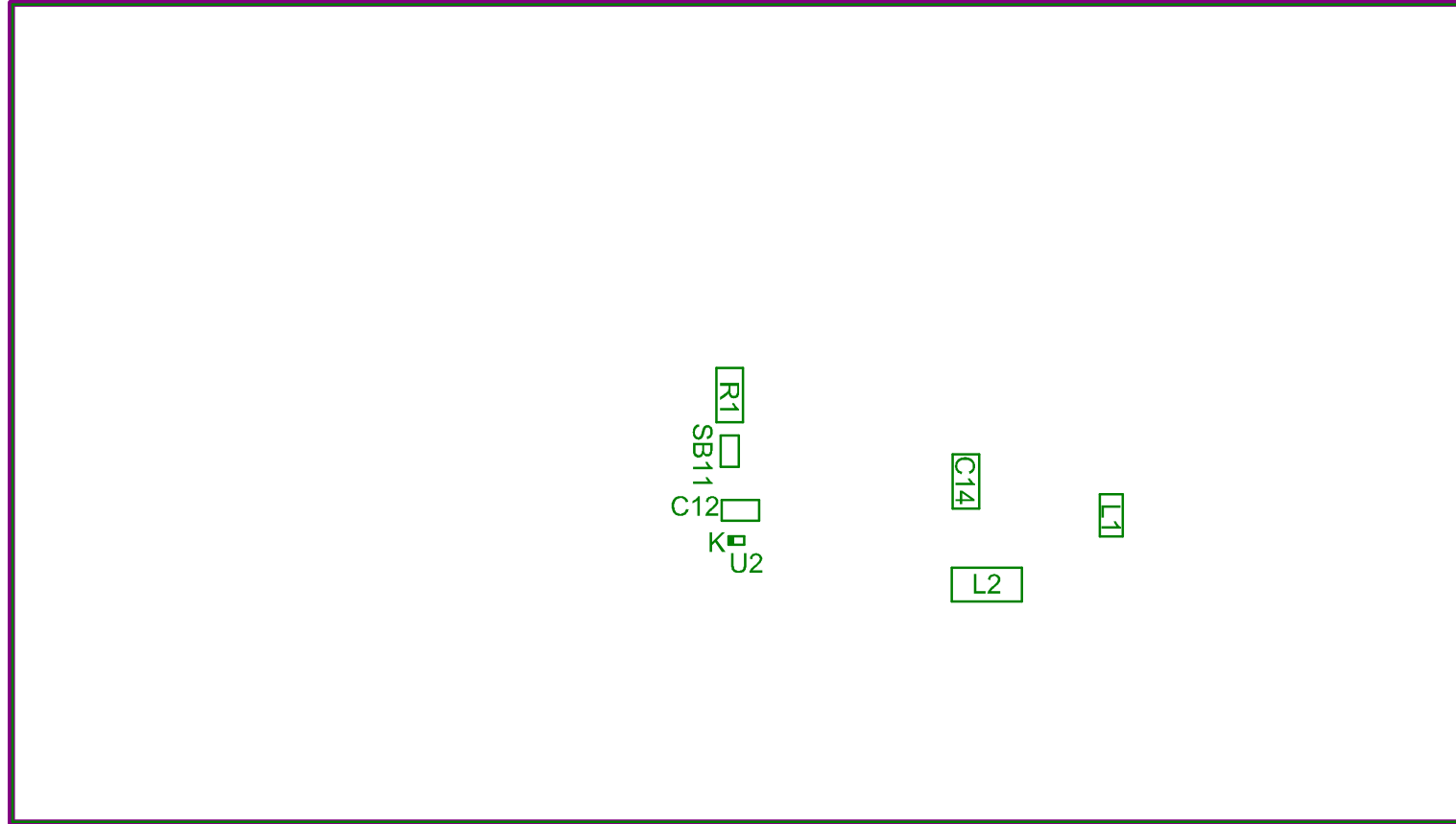
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Project: STM32WL_QFN48_4Layers_WMBUS169MHz_Ref		
Variant: [No Variations]		
Revision: A-01	Reference: MB1792	
Size: A4	Date: 01-04-2022	Sheet: 1 of 2




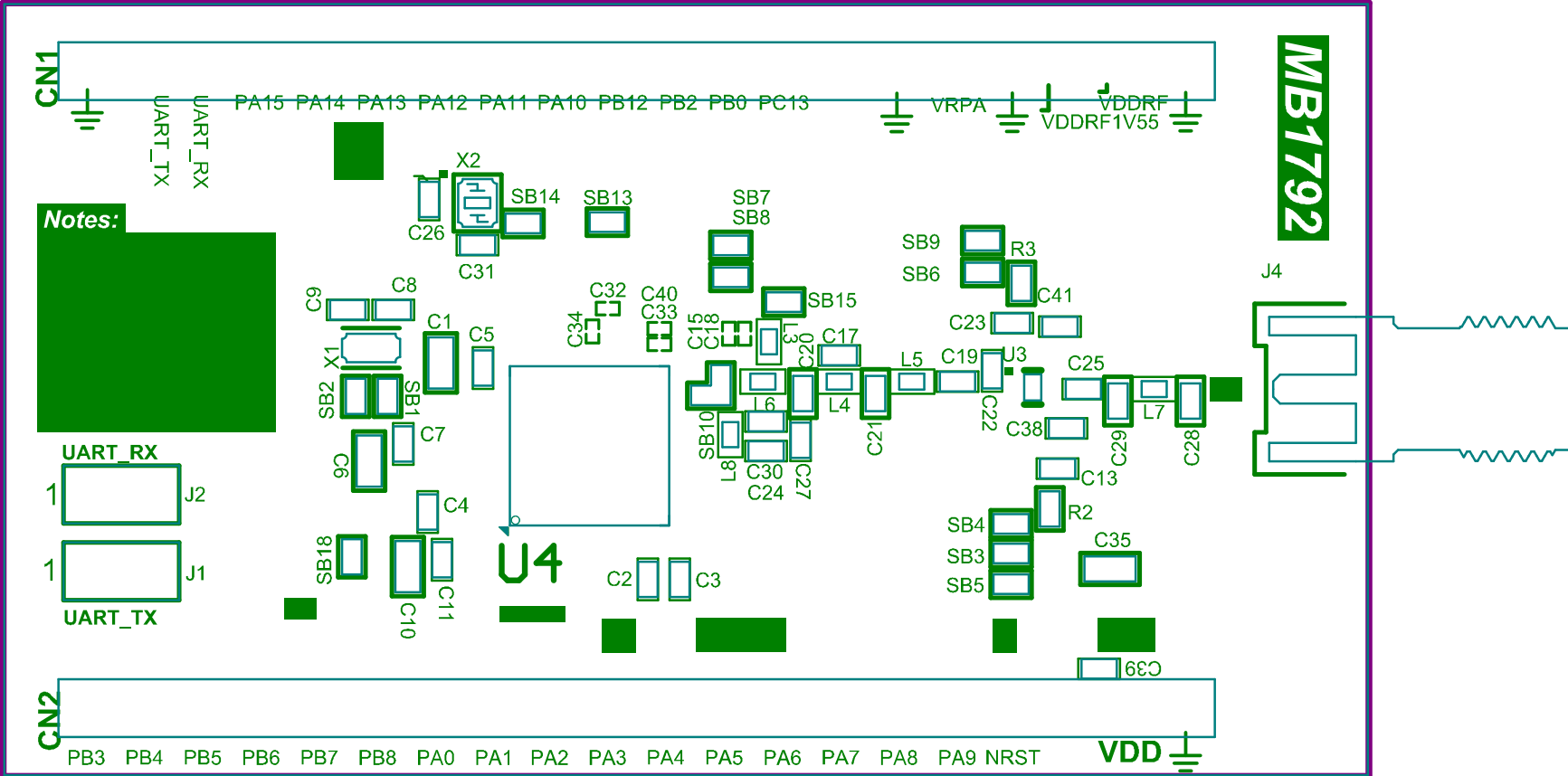




Project: STM32WL_QFN48_4Layers_WMBUS169MHz_RefBoard		
Layer: Top Assembly	Gerber: .GM14	
Variant: [No Variations]	Ref: MB1792	
Date: 01-04-2022	Rev: A	

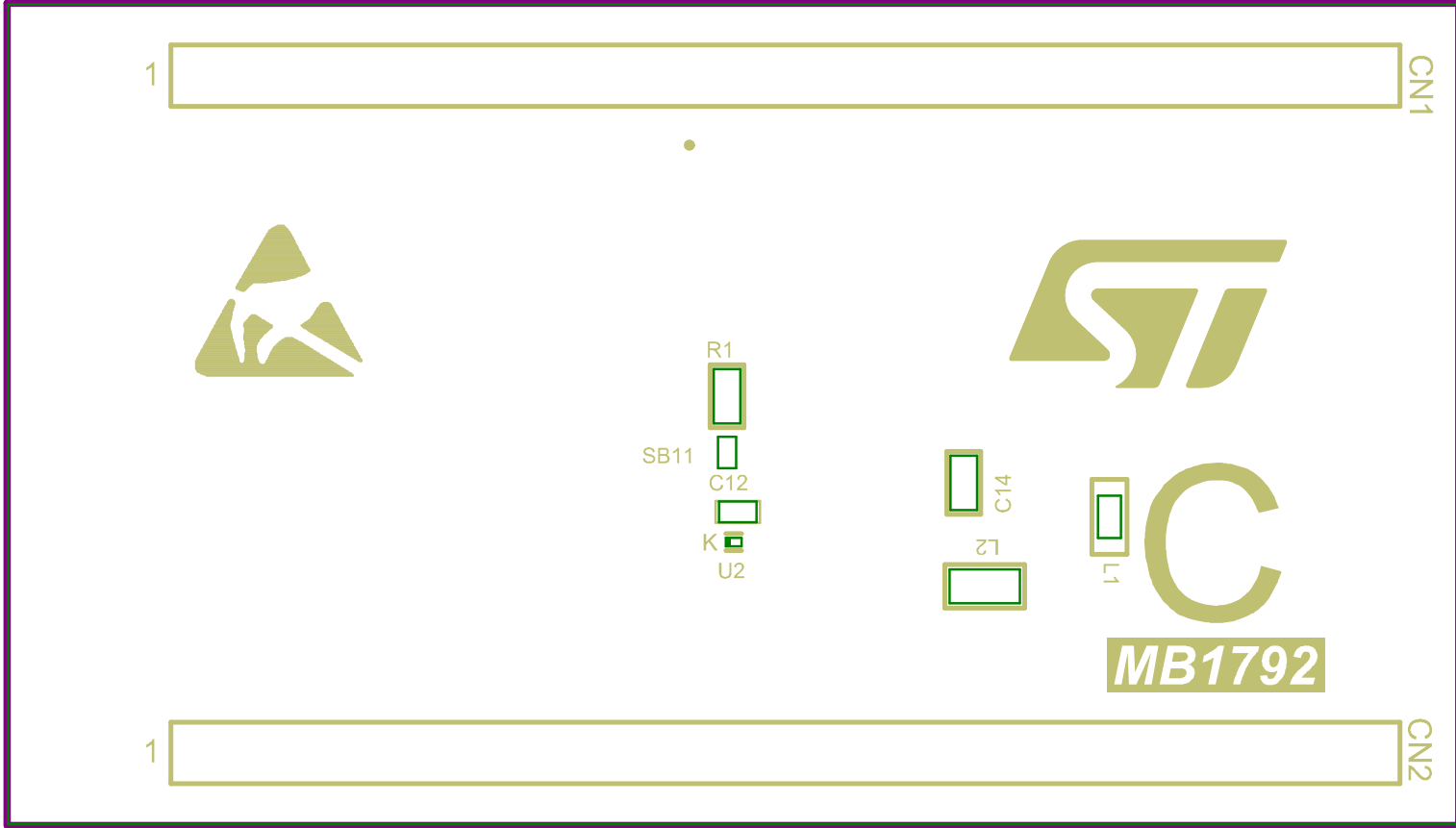


Project: STM32WL_QFN48_4Layers_WMBUS169MHz_RefBoard		
Layer: Bottom Assembly	Gerber:.GM15	
Variant: [No Variations]	Ref: MB1792	
Date: 01-04-2022	Rev: A	



Top Overlay

.GTO



Bottom Overlay

.GBO